



IFW

PATENT APPLICATION  
Docket No. 9903-078  
Client No. S02US013

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Young-Hee Song, et al.      Conf. No.      9556  
Serial No.      10/651,813      Examiner:      Williams, Alexander O  
Filed:      August 28, 2003      Art Unit:      2826  
For:      SEMICONDUCTOR CHIP HAVING BOND PADS  
AND MULTI-CHIP PACKAGE

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE TO ELECTION REQUIREMENT

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:  
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Adrienne Chocholak